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Sensors and Communication Technologies in the 1 GHz to 10 THz Band

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18–19 September 2024 Edinburgh, United Kingdom

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Published by SPIE

Volume 13203

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Please use the following format to cite material from these proceedings: Author(s), "Title of Paper," in Sensors and Communication Technologies in the 1 GHz to 10 THz Band, edited by Neil A. Salmon, Wladislaw Michailow, Proc. of SPIE 13203, Seven-digit Article CID Number (DD/MM/YYYY); (DOI URL).

ISSN: 0277-786X

ISSN: 1996-756X (electronic)

ISBN: 9781510681149

ISBN: 9781510681156 (electronic)

Published by

SPIE

P.O. Box 10, Bellingham, Washington 98227-0010 USA Telephone +1 360 676 3290 (Pacific Time)

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